SEIKO EPSON CORPORATION

CRYSTAL OSCILLATOR (SPXO) OUTPUT : CMOS Low Jitter	Pb RoIIS Product Number (please contact us) Free Compliant X1G0029x1xxxx00
SG - 210 S*D •Frequency range •Supply voltage •Current consumption •Current consumption •Function •External dimensions •Standby(ST) •External dimensions	Actual size

Specifications (characteristics)

Itom	Symbol	Specifications			Conditions / Remarks
Item		SG-210SED	SG-210SDD	SG-210SCD	Conditions / Remarks
Output frequency range	fo	50.000 MHz to 80.000 MHz		Please contact us about available frequencies.	
Supply voltage	Vcc	1.8 V Typ. 1.6 V to 2.2 V	2.5 V Typ. 2.2 V to 3.0 V	3.3 V Typ. 2.7 V to 3.6 V	
Storage temperature	T_stg	-40 °C to +125 °C			Storage as single product.
Operating temperature	T_use	-40 °C to +85 °C			
Frequency tolerance		B: ±50 × 10 ⁻⁶ , C: ±100 × 10 ⁻⁶			-20 °C to +70 °C
	f_tol	L: ±50 × 10 ⁻⁶ , M: ±100 × 10 ⁻⁶			-40 °C to +85 °C
Current consumption	Icc	6.0 mA Max.	7.0 mA Max.	8.0 mA Max.	No load condition
Stand-by current	I_std		10.0 µA Max.		ST =GND
Symmetry	SYM		45 % to 55 %		50 % Vcc level,L_CMOS ≤ 30 pF
	Vон	Vcc -0.4 V Min.			IOH=-8 mA(SCD,SDD), -4 mA(SED)
Output voltage	Vol	0.4 V Max.			IOL= 8 mA(SCD,SDD), 4 mA(SED)
Output load condition (CMOS)	L_CMOS	30 pF Max.			
Input voltage	Vін	70 % Vcc Min.			ST terminal
	VIL	30 % Vcc Max.			
Rise time / Fall time	tr/ tf	4 ns Max.			20 % Vcc to 80 % Vcc level, L_CMOS ≤ 30 pF
Start-up time	t_str	2 ms Max.			t=0 at 90 % Vcc
•	foring	±3 × 10 ⁻⁶ / year Max			+25 °C, First year, Vcc= 1.8 V, 2.5 V, 3.3 V
	f_aging	$\pm 10 \times 10^{-6}$ / 10 years Max.			+25 °C, 10 years, Vcc= 1.8 V, 2.5 V, 3.3 V
Jitter *1	tDJ	0.1 ps Typ. 0.1 ps Typ.			Deterministic Jitter
	tRJ	3.2 ps Typ. 2.7 ps Typ.		Random Jitter	
	trms	30 ps Typ. 25 ps Typ.		Тур.	Peak to PeakL_CMOS \leq 15 pF
Phase Jitter	tPJ	1.0 ps Max.			Offset frequency: 12 kHz to 20 MHz

*1 Tested using a DTS-2075 Digital timing system made by WAVECREST with jitter analysis software VISI6.

Product Name (Standard form)

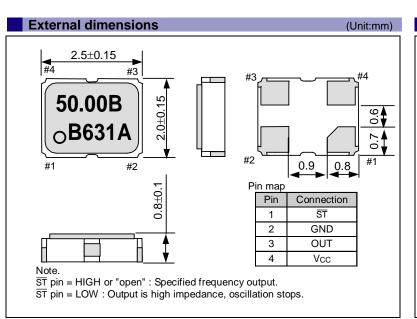
 SG-210 S E D
 50.000000MHz
 L

 ①
 ⑦
 ③
 ⑤

 ①Model
 ②Function (S:Standby)
 ③Supply voltage

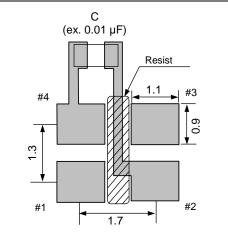
 ④Frequency
 ⑤Frequency tolerance

3S	upply voltage	ļ	⑤Frequency tolerance	
Е	1.8 V Typ.		В	±50 × 10 ⁻⁶ / -20 to +70°C
D	2.5 V Typ.		С	±100 × 10 ⁻⁶ / -20 to +70°C
С	3.3 V Typ.		L	±50 × 10 ⁻⁶ / -40 to +85°C
		- F	М	±100 × 10 ⁻⁶ / -40 to +85°C



Footprint (Recommended)

(Unit:mm)



To maintain stable operation, provide a 0.01μ F to 0.1μ F by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs,

Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired ISO/TS 16949 certification that is requested strongly by major automotive manufacturers as standard.

Explanation of the mark that are using it for the catalog

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Pb Free	► Pb free.
RoHS	 Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
For Automotive	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
Automotive Safety	► Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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